

## General Description

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® S series is optimized for its switching characteristics to achieve aggressive EMI standards. It is easy to use for smaller power supply systems to meet the both efficiency and EMI standards.

## Features

- Low  $R_{DS(ON)}$  & FOM
- Extremely low switching loss
- Excellent stability and uniformity



## Applications

- LED lighting
- Charger
- Adapter
- Telecom power
- Server power
- Solar/UPS

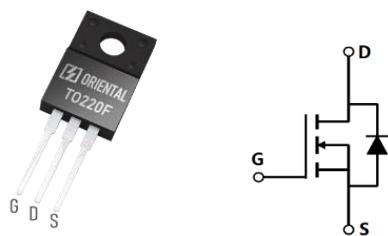
## Key Performance Parameters

| Parameter                         | Value | Unit |
|-----------------------------------|-------|------|
| $V_{DS}$                          | 650   | V    |
| $I_D$ , pulse                     | 24    | A    |
| $R_{DS(ON)}$ , max @ $V_{GS}=10V$ | 580   | mΩ   |
| $Q_g$                             | 12.3  | nC   |

## Marking Information

| Product Name | Package | Marking     |
|--------------|---------|-------------|
| OSG65R580FSF | TO220F  | OSG65R580FS |

## Package & Pin Information



**Absolute Maximum Ratings** at  $T_j=25^\circ\text{C}$  unless otherwise noted

| Parameter   | Symbol               | Value      | Unit             |
|---|----------------------|------------|------------------|
| Drain-source voltage  | $V_{DS}$             | 650        | V                |
| Gate-source voltage   | $V_{GS}$             | $\pm 30$   | V                |
| Continuous drain current <sup>1)</sup> , $T_C=25\text{ }^\circ\text{C}$         | $I_D$                | 8          | A                |
| Continuous drain current <sup>1)</sup> , $T_C=100\text{ }^\circ\text{C}$        |                      | 5          |                  |
| Pulsed drain current <sup>2)</sup> , $T_C=25\text{ }^\circ\text{C}$             | $I_{D,\text{pulse}}$ | 24         | A                |
| Continuous diode forward current <sup>1)</sup> , $T_C=25\text{ }^\circ\text{C}$ | $I_S$                | 8          | A                |
| Diode pulsed current <sup>2)</sup> , $T_C=25\text{ }^\circ\text{C}$             | $I_{S,\text{pulse}}$ | 24         | A                |
| Power dissipation <sup>3)</sup> , $T_C=25\text{ }^\circ\text{C}$                | $P_D$                | 28         | W                |
| Single pulsed avalanche energy <sup>4)</sup>                                    | $E_{AS}$             | 150        | mJ               |
| MOSFET dv/dt ruggedness, $V_{DS}=0\text{...}480\text{ V}$                       | dv/dt                | 50         | V/ns             |
| Reverse diode dv/dt, $V_{DS}=0\text{...}480\text{ V}$ , $I_{SD}\leq I_D$        | dv/dt                | 10         | V/ns             |
| Operation and storage temperature   | $T_{stg}, T_j$       | -55 to 150 | $^\circ\text{C}$ |

**Thermal Characteristics**

| Parameter                            | Symbol          | Value | Unit               |
|--------------------------------------|-----------------|-------|--------------------|
| Thermal resistance, junction-case    | $R_{\theta JC}$ | 4.5   | $^\circ\text{C/W}$ |
| Thermal resistance, junction-ambient | $R_{\theta JA}$ | 62.5  | $^\circ\text{C/W}$ |

**Electrical Characteristics** at  $T_j=25^\circ\text{C}$  unless otherwise specified

| Parameter                        | Symbol              | Min. | Typ. | Max. | Unit          | Test condition  |
|----------------------------------|---------------------|------|------|------|---------------|---|
| Drain-source breakdown voltage   | $BV_{DSS}$          | 650  |      |      | V             | $V_{GS}=0\text{ V}$ , $I_D=250\text{ }\mu\text{A}$                        |
| Gate threshold voltage           | $V_{GS(\text{th})}$ | 2.9  |      | 3.9  | V             | $V_{DS}=V_{GS}$ , $I_D=250\text{ }\mu\text{A}$                            |
| Drain-source on-state resistance | $R_{DS(\text{ON})}$ |      | 0.50 | 0.58 | $\Omega$      | $V_{GS}=10\text{ V}$ , $I_D=4\text{ A}$                                   |
|                                  |                     |      | 1.28 |      |               | $V_{GS}=10\text{ V}$ , $I_D=4\text{ A}$ , $T_j=150\text{ }^\circ\text{C}$ |
| Gate-source leakage current      | $I_{GSS}$           |      |      | 100  | nA            | $V_{GS}=30\text{ V}$  |
|                                  |                     |      |      | -100 |               | $V_{GS}=-30\text{ V}$   |
| Drain-source leakage current     | $I_{DSS}$           |      |      | 1    | $\mu\text{A}$ | $V_{DS}=650\text{ V}$ , $V_{GS}=0\text{ V}$                               |

### Dynamic Characteristics

| Parameter                    | Symbol              | Min. | Typ.  | Max. | Unit | Test condition   |
|------------------------------|---------------------|------|-------|------|------|--|
| Input capacitance            | C <sub>iss</sub>    |      | 535.8 |      | pF   | V <sub>GS</sub> =0 V,<br>V <sub>DS</sub> =50 V,<br>f=1 MHz                                       |
| Output capacitance           | C <sub>oss</sub>    |      | 43.4  |      | pF   |  |
| Reverse transfer capacitance | C <sub>rss</sub>    |      | 2.3   |      | pF   |  |
| Turn-on delay time           | t <sub>d(on)</sub>  |      | 27.4  |      | ns   | V <sub>GS</sub> =10 V,<br>V <sub>DS</sub> =400 V,<br>R <sub>G</sub> =2 Ω,<br>I <sub>D</sub> =4 A |
| Rise time                    | t <sub>r</sub>      |      | 14.8  |      | ns   |  |
| Turn-off delay time          | t <sub>d(off)</sub> |      | 73.4  |      | ns   |  |
| Fall time                    | t <sub>f</sub>      |      | 7.3   |      | ns   |  |

### Gate Charge Characteristics

| Parameter            | Symbol               | Min. | Typ. | Max. | Unit | Test condition   |
|----------------------|----------------------|------|------|------|------|--|
| Total gate charge    | Q <sub>g</sub>       |      | 12.3 |      | nC   | V <sub>GS</sub> =10 V,<br>V <sub>DS</sub> =400 V,<br>I <sub>D</sub> =4 A |
| Gate-source charge   | Q <sub>gs</sub>      |      | 2.3  |      | nC   |  |
| Gate-drain charge    | Q <sub>gd</sub>      |      | 5.7  |      | nC   |  |
| Gate plateau voltage | V <sub>plateau</sub> |      | 5.9  |      | V    |  |

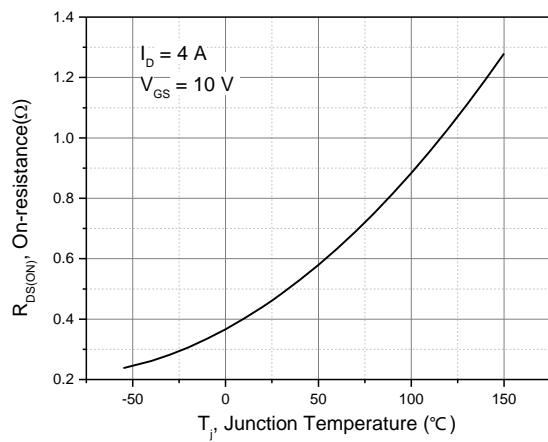
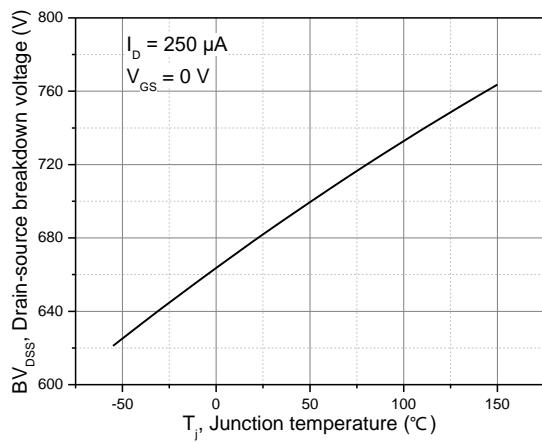
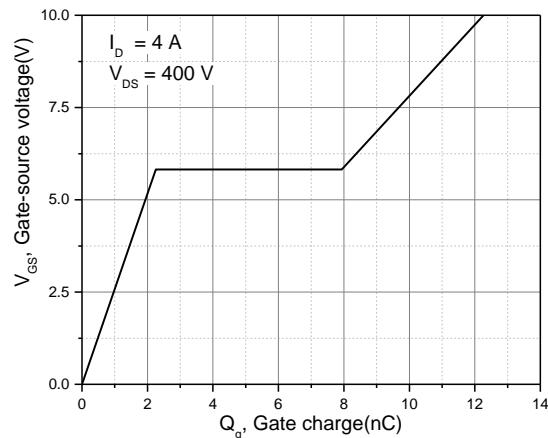
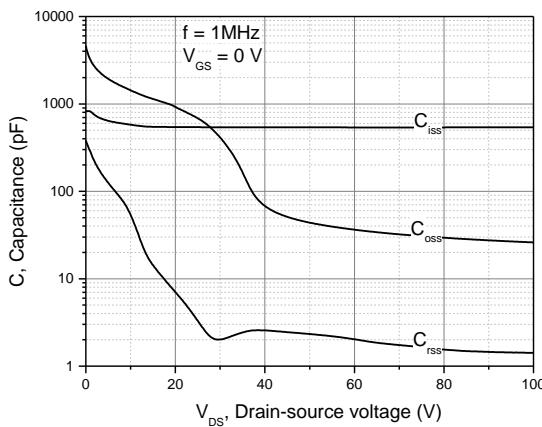
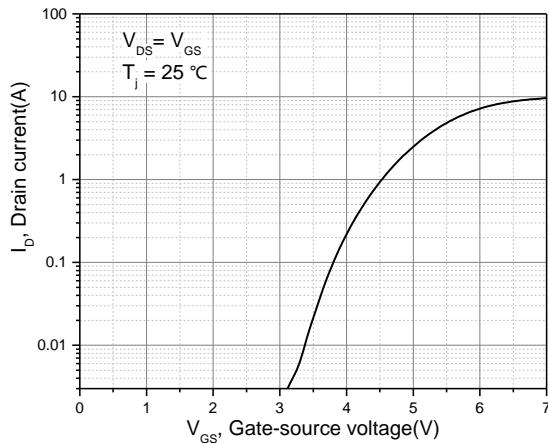
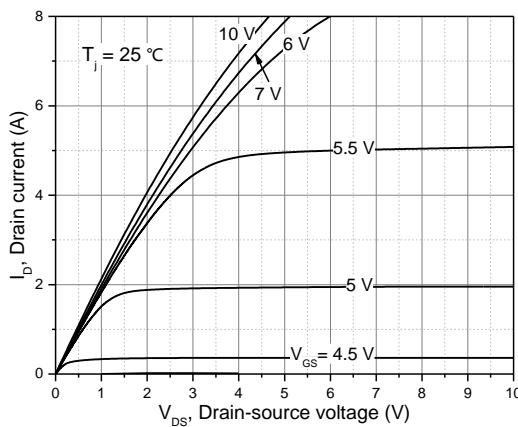
### Body Diode Characteristics

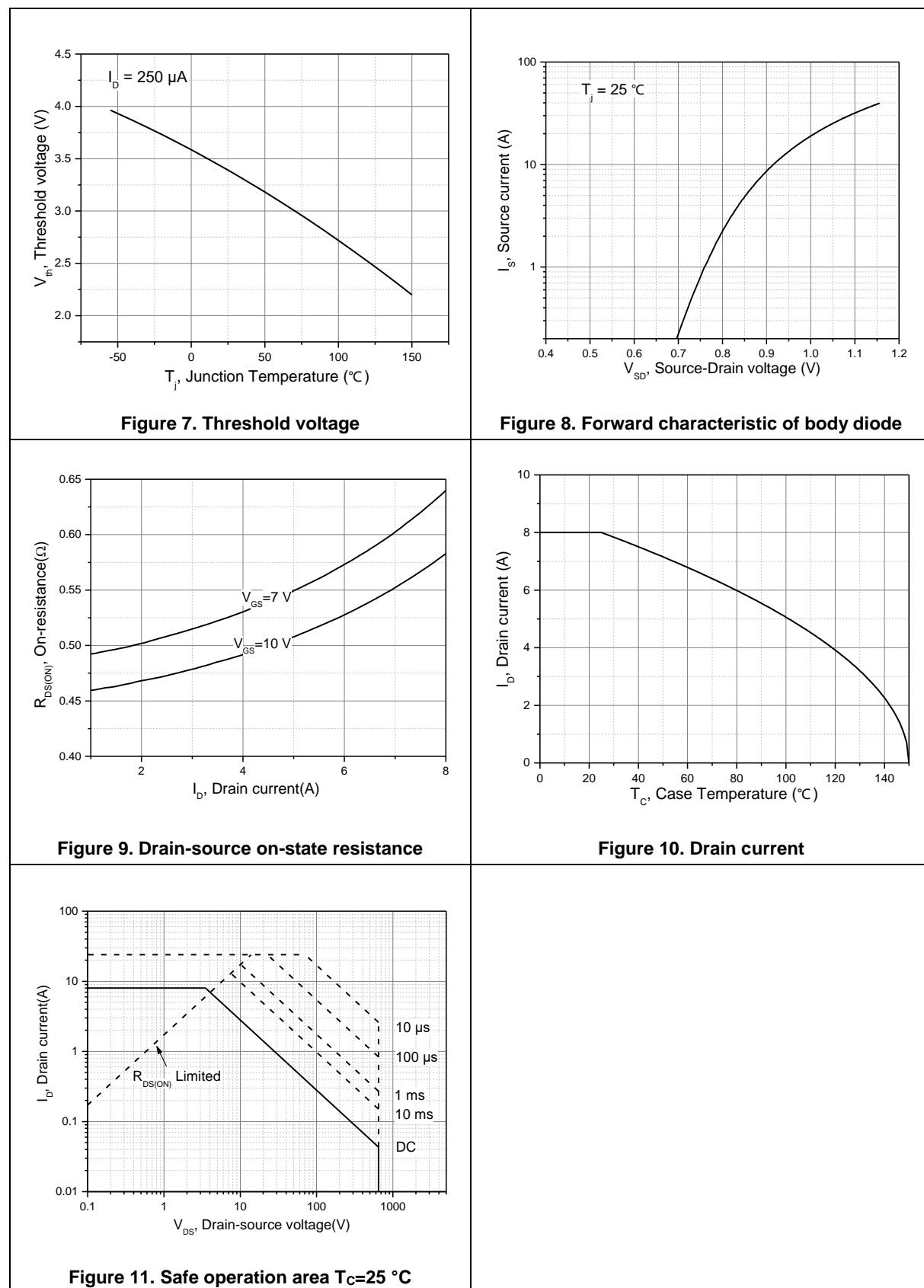
| Parameter                     | Symbol           | Min. | Typ.  | Max. | Unit | Test condition                               |
|-------------------------------|------------------|------|-------|------|------|--|
| Diode forward voltage         | V <sub>SD</sub>  |      |       | 1.2  | V    | I <sub>S</sub> =8 A,<br>V <sub>GS</sub> =0 V |
| Reverse recovery time         | t <sub>rr</sub>  |      | 227.5 |      | ns   |  |
| Reverse recovery charge       | Q <sub>rr</sub>  |      | 1.0   |      | μC   |  |
| Peak reverse recovery current | I <sub>rrm</sub> |      | 7.8   |      | A    |  |

### Note

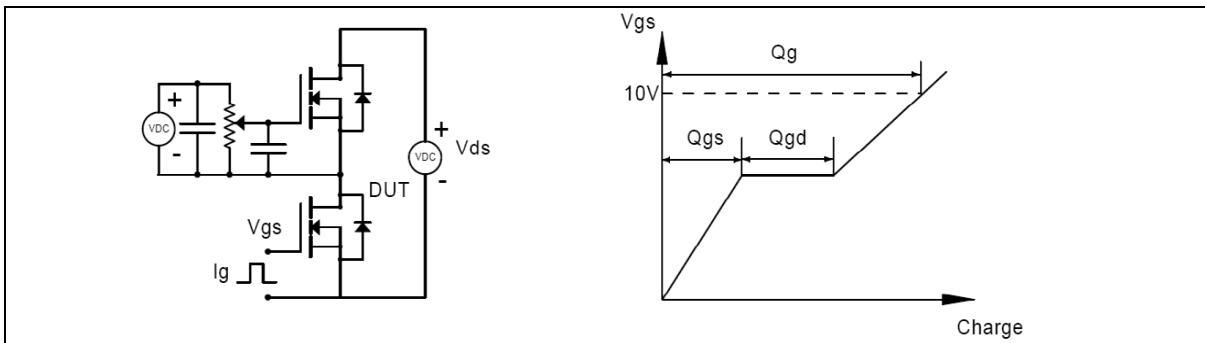
- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) V<sub>DD</sub>=50 V, V<sub>GS</sub>=10 V, L=60 mH, starting T<sub>j</sub>=25 °C.

### Electrical Characteristics Diagrams

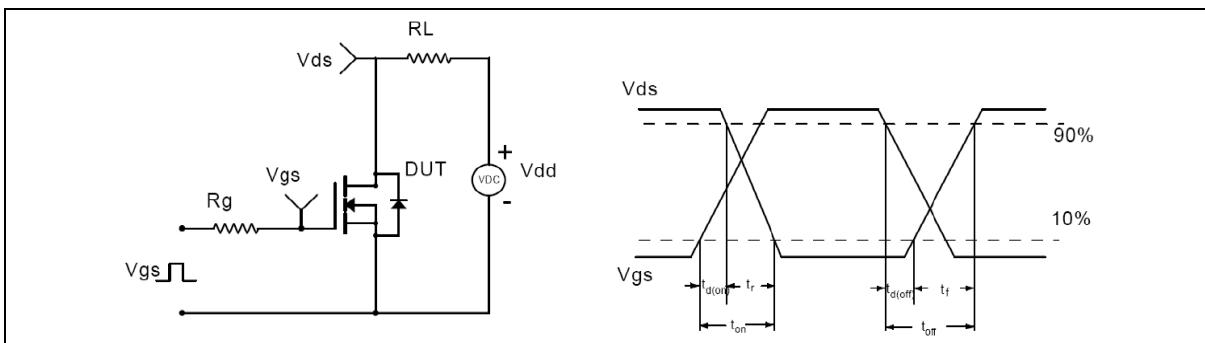




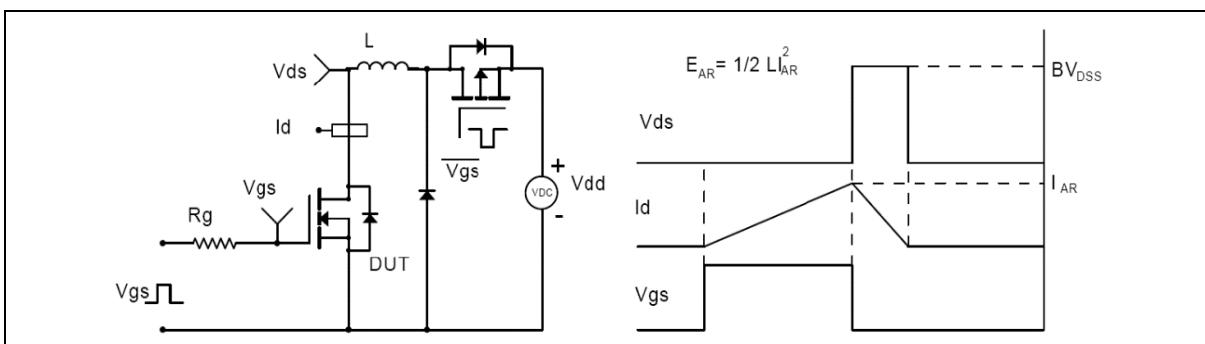
### Test circuits and waveforms



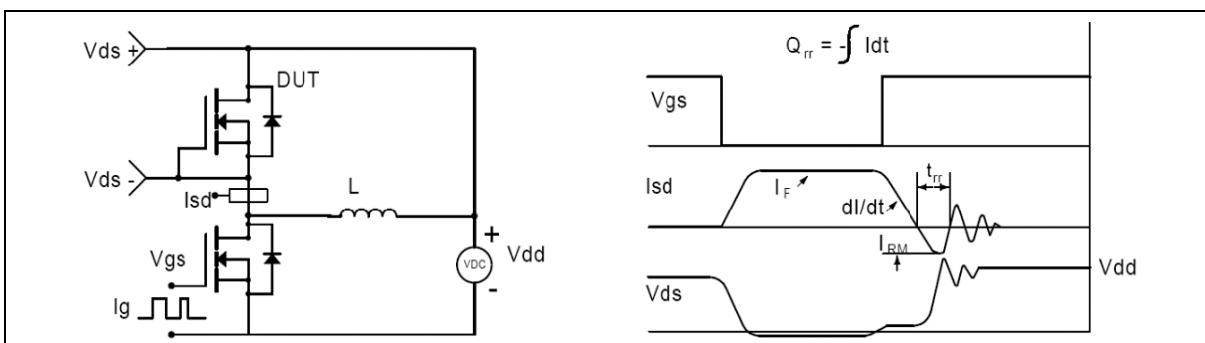
**Figure 1. Gate charge test circuit & waveform**



**Figure 2. Switching time test circuit & waveforms**

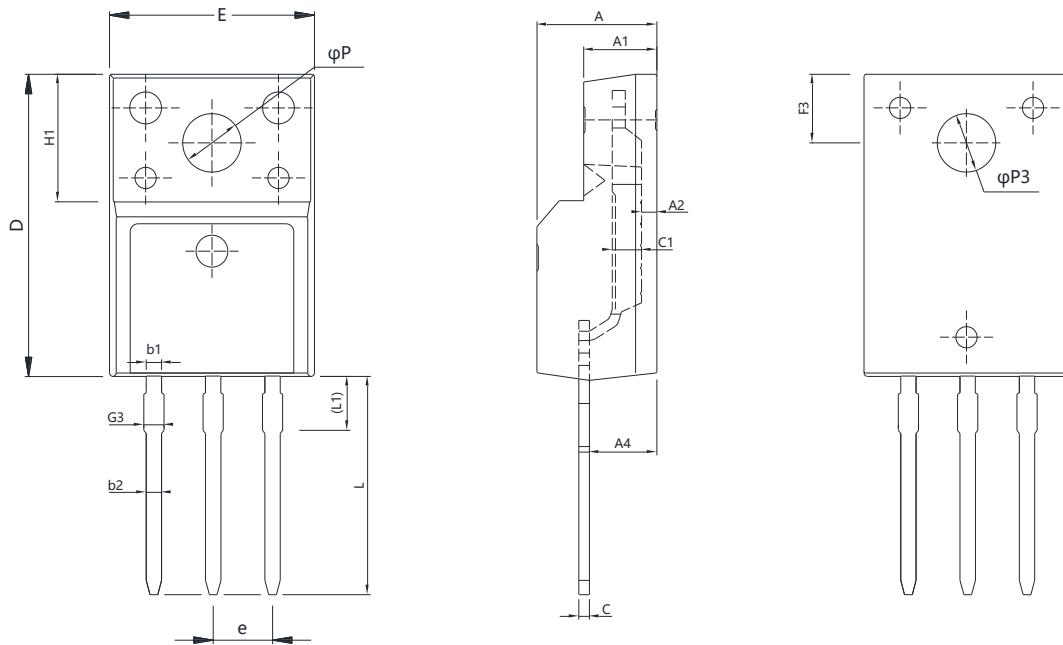


**Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms**



**Figure 4. Diode reverse recovery test circuit & waveforms**

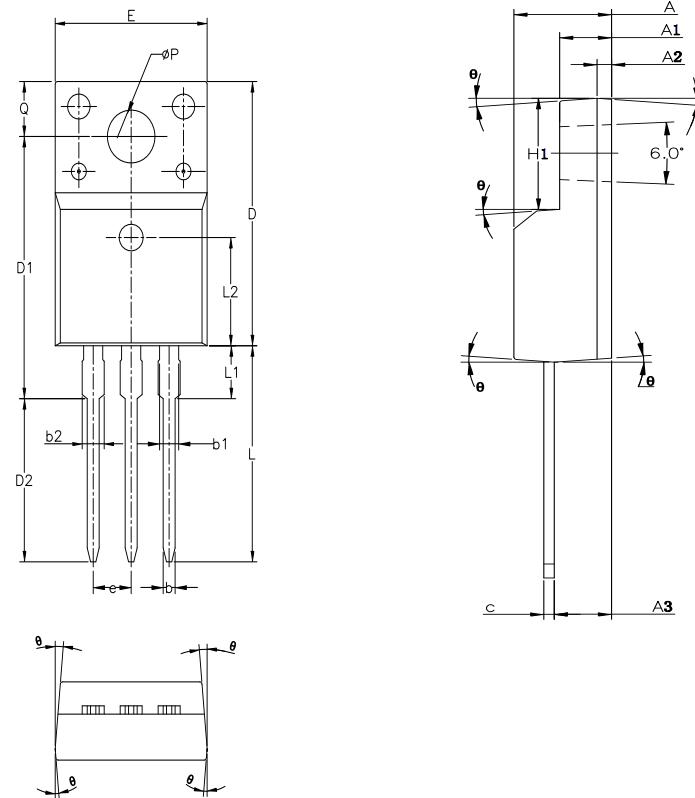
## Package Information



| Symbol | mm      |       |       |
|--------|---------|-------|-------|
|        | Min     | Nom   | Max   |
| E      | 9.96    | 10.16 | 10.36 |
| A      | 4.50    | 4.70  | 4.90  |
| A1     | 2.34    | 2.54  | 2.74  |
| A2     | 0.30    | 0.45  | 0.60  |
| A4     | 2.56    | 2.76  | 2.96  |
| c      | 0.40    | 0.50  | 0.65  |
| C1     | 1.20    | 1.30  | 1.35  |
| D      | 15.57   | 15.87 | 16.17 |
| H1     | 6.70REF |       |       |
| e      | 2.54BSC |       |       |
| L      | 12.68   | 12.98 | 13.28 |
| L1     | 2.88    | 3.03  | 3.18  |
| ΦP     | 3.03    | 3.18  | 3.38  |
| ΦP3    | 3.15    | 3.45  | 3.65  |
| F3     | 3.15    | 3.30  | 3.45  |
| G3     | 1.25    | 1.35  | 1.55  |
| b1     | 1.18    | 1.28  | 1.43  |
| b2     | 0.70    | 0.80  | 0.95  |

Version 1: TO220F-P package outline dimension

## Package Information



| Symbol | mm      |       |       |
|--------|---------|-------|-------|
|        | Min     | Nom   | Max   |
| A      | 4.40    | 4.50  | 4.60  |
| A1     | 1.27    | 1.30  | 1.33  |
| A2     | 2.30    | 2.40  | 2.50  |
| b      | 0.70    | -     | 0.90  |
| b1     | 1.27    | -     | 1.40  |
| c      | 0.45    | 0.50  | 0.60  |
| D      | 15.30   | 15.70 | 16.10 |
| D1     | 9.10    | 9.20  | 9.30  |
| D2     | 13.10   | -     | 13.70 |
| E      | 9.70    | 9.90  | 10.20 |
| E1     | 7.80    | 8.00  | 8.20  |
| e      | 2.54BSC |       |       |
| e1     | 5.08BSC |       |       |
| H1     | 6.30    | 6.50  | 6.70  |
| L      | 12.78   | 13.08 | 13.38 |
| L1     | -       | -     | 3.50  |
| L2     | 4.60REF |       |       |
| ΦP     | 3.55    | 3.60  | 3.65  |
| Q      | 2.73    | -     | 2.87  |
| θ1     | 1°      | 3°    | 5°    |

Version 2: TO220F-J package outline dimension

## Ordering Information

| Package Type | Units/Tube | Tubes/Inner Box | Units/Inner Box | Inner Boxes/Carton Box | Units/Carton Box |
|--------------|------------|-----------------|-----------------|------------------------|------------------|
| TO220F-P     | 50         | 20              | 1000            | 6                      | 6000             |
| TO220F-J     | 50         | 20              | 1000            | 5                      | 5000             |

## Product Information

| Product      | Package | Pb Free | RoHS | Halogen Free |
|--------------|---------|---------|------|--------------|
| OSG65R580FSF | TO220F  | yes     | yes  | yes          |

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